imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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T-1 (3mm) BI-LEVEL LED INDICATOR

Part Number: WP934MD/LILGD

High Efficiency Red Green

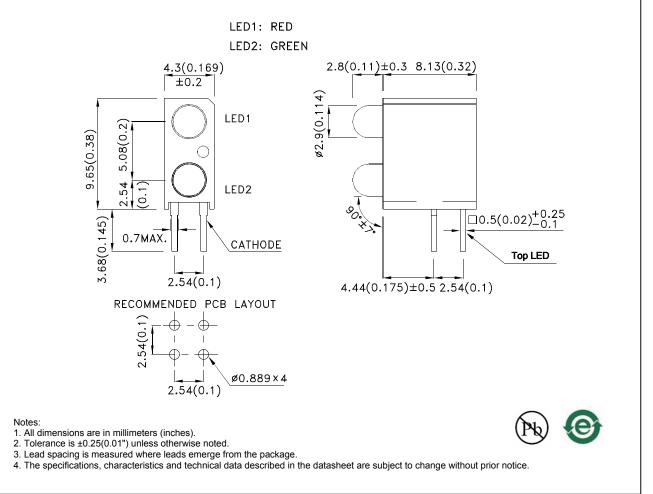
Features

- Pre-trimmed leads for pc mounting.
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability life measured in years.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- Low current IF=2mA operating.
- RoHS compliant.

Descriptions

- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.
- The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



DATE: APR/12/2016 DRAWN: M.Liu PAGE: 1 OF 6 ERP: 1102013647

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
			Min.	Тур.	201/2
WP934MD/LILGD	High Efficiency Red (GaAsP/GaP)	Ded Diffused	0.35	1	40°
		Red Diffused	*0.2	*0.6	
	Green (GaP)	Crear Diffused	1	2	40°
		Green Diffused	*1	*2	

Notes:

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous Flux: +/-15%.
* Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	High Efficiency Red Green	627 565		nm	IF=2mA	
λD [1]	Dominant Wavelength	High Efficiency Red Green	617 568		nm	I⊧=2mA	
Δλ1/2	Spectral Line Half-width	High Efficiency Red Green	45 30		nm	I⊧=2mA	
С	Capacitance	High Efficiency Red Green	15 15		pF	VF=0V;f=1MHz	
Vf [2]	Forward Voltage	High Efficiency Red Green	1.7 1.9	2.5 2.5	V	IF=2mA	
lr	Reverse Current	High Efficiency Red Green		10 10	uA	VR = 5V	

Notes:

1. Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

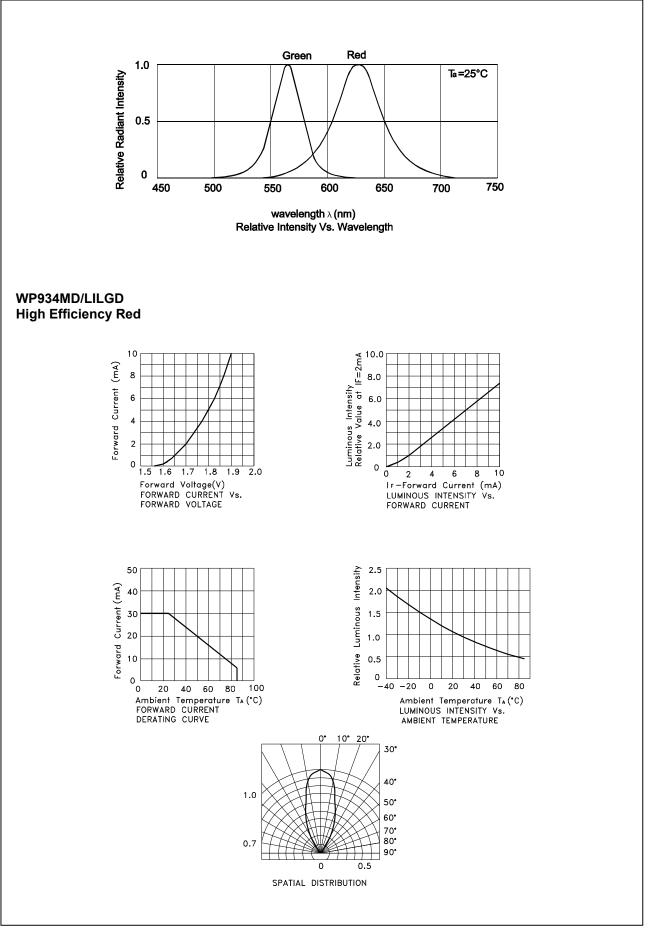
Absolute Maximum Ratings at TA=25°C

High Efficiency Red	Green	Units		
75	62.5	mW		
30	25	mA		
160	140	mA		
Į	V			
-40°C To +85°C				
260°C For 3 Seconds				
260°C For 5 Seconds				
	75 30 160	75 62.5 30 25 160 140 5 -40°C To +85°C 260°C For 3 Seconds		

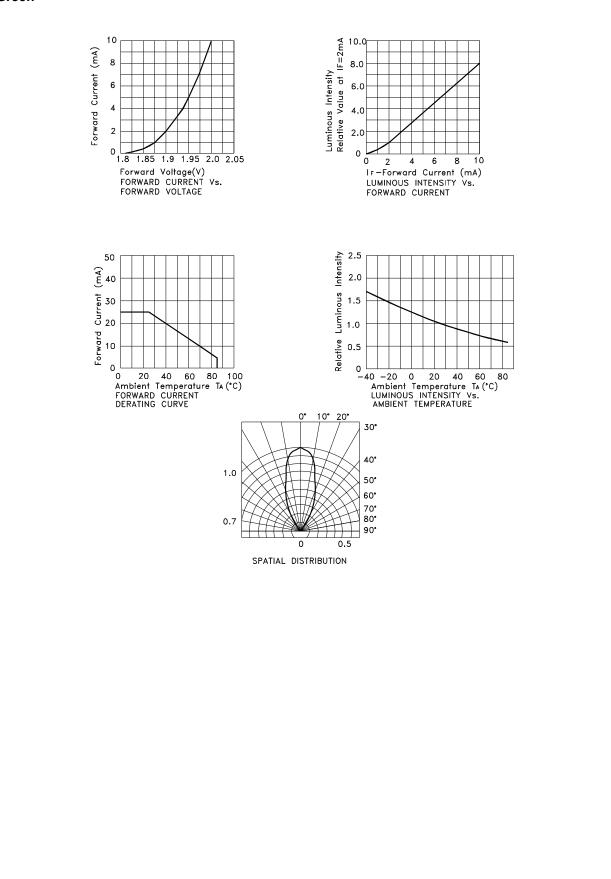
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. 2mm below package base.

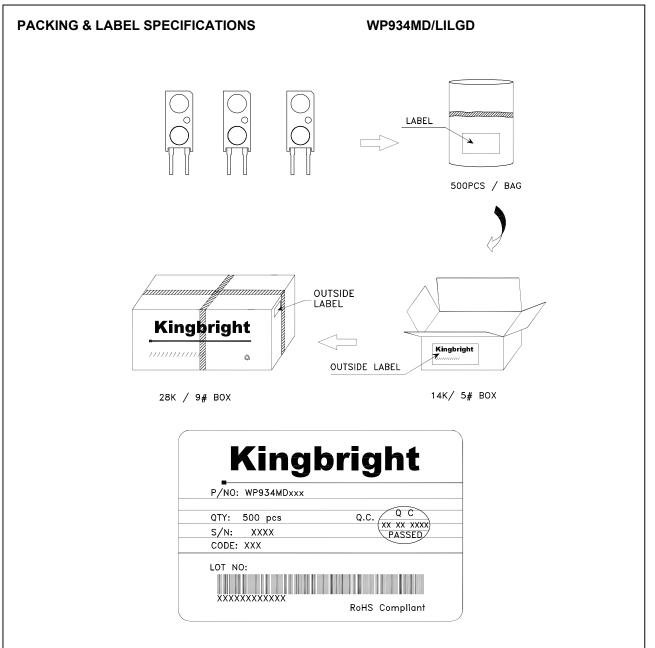
3. 5mm below package base.

Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.









Terms and conditions for the usage of this document

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.

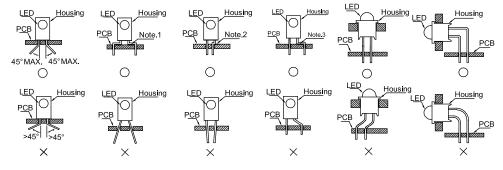
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PRECAUTIONS

1. Storage conditions:

a.Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.

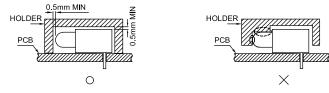
- b.LEDs should be stored with temperature $\leq 30^{\circ}$ C and relative humidity < 60%.
- c.Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.
- The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.



" () " Correct mounting method " imes " Incorrect mounting method

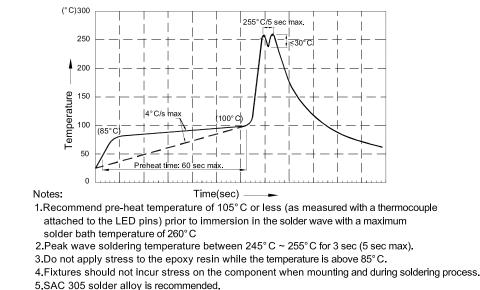
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

3. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



4. The tip of the soldering iron should never touch the lens epoxy.

- 5. Through-hole LEDs are incompatible with reflow soldering.
- 6. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 7. Recommended Wave Soldering Profiles:



6.No more than one wave soldering pass.